| FEATURES | BENEFITS |
|--|--|
| Highest level of integration | Reduces system BOM and discrete component count |
| Smallest footprint | Saves board space |
| Pin-compatible options | Provides design flexibility to develop one design and populate the voice socket with the right features for a given market—100 V or 150 V, narrow band or wide band, internal balanced (sinusoidal or trapezoidal) or unbalanced ringing |
| Lowest power solution across all operating modes | Provides best solution for battery-backed and power- sensitive applications |
| Highly programmable | Offers design flexibility to develop one application for worldwide markets |
| Integrated ring cadencing and system state control | Reduces real-time software overhead |
| Comprehensive line sensing | Enables high performance 909 diagnostics and subscriber loop test and self test support |
| Integrated switching regulator | Enables lowest component count and highest efficiency in all states of operation |

Related Literature

■ 081165 Le88111/131 VoicePort™ Device Data Sheet*

*Contact your Zæ|ā \ Sales Representative to obtain the data sheet.

Packaging and Availability

See Ordering Information on first page.

For More Information:

To find the Zæ∣∄ \ Sales Office nearest you, visit our website at

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